

Output Rail-to-Rail Very Low Noise Operational Amplifier

- Rail-to-rail output voltage swing ($\pm 2.4V$ @ $V_{cc} = \pm 2.5V$)
- Very low noise level: $4nV/\sqrt{Hz}$
- Ultra low distortion: 0.003%
- High dynamic features (12mHz, $4V/\mu s$)
- Operating range: 2.7V to 10V
- ESD protection (2kV)
- Latch-up immunity (class A)
- Available in SOT23-5 & 3x3 QFN8 micropackage

Description

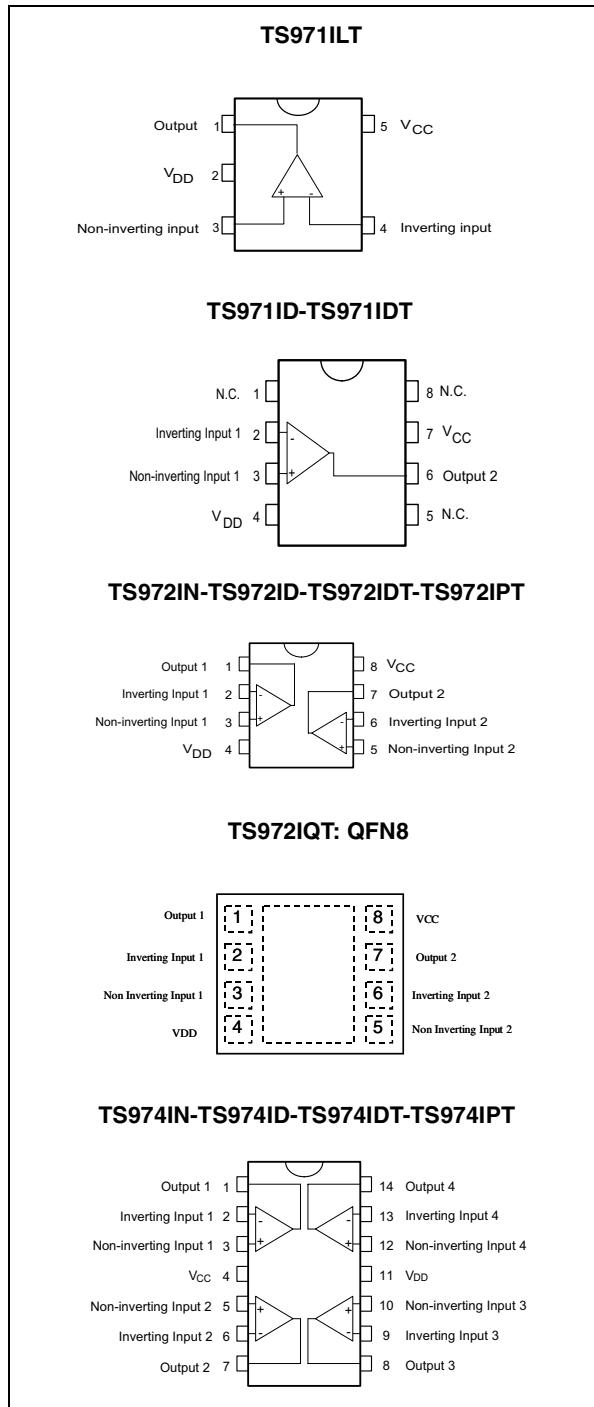
The TS97x family operational amplifiers is able to operate with voltages as low as $\pm 1.35V$ and featuring output rail-to-rail signal swing. The TS97x boasts characteristics that make them particularly well suited for portable and battery-supplied equipment. Very low noise and low distortion characteristics make them ideal for audio pre-amplification.

The TS971 is housed in the space-saving 5 pins SOT23 package which simplifies the board design because of the ability to be placed everywhere (outside dimensions are 2.8mm x 2.9mm).

Applications

- Portable equipment (CD players, PDA)
- Portable communications (cell phones, pagers)
- Instrumentation & sensing
- Professional audio circuits

Pin Connections (top view)



Order Codes

Part Number	Temperature Range	Package	Packaging	Marking
TS971ID/IDT	-40°C, +125°C	SO	Tube or Tape & Reel	
TS971ILT		SOT23-5L	Tape & Reel	K120
TS972IN		DIP	Tube	
TS972ID/IDT		SO	Tube or Tape & Reel	
TS972IPT		TSSOP (Thin Shrink Outline Package)	Tape & Reel	
TS972IQT		QFN (dual micro lead frame package)	Tape & Reel	
TS974IN		DIP	Tube	
TS974ID/IDT		SO	Tube or Tape & Reel	
TS974IPT		TSSOP (Thin Shrink Outline Package)	Tape & Reel	

1 Absolute Maximum Ratings

Table 1: Key parameters and their absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage ¹	12	V
V_{id}	Differential Input Voltage ²	$\pm V_{CC}$	V
V_{in}	Input Voltage ³	$V_{DD}-0.3$ to $V_{CC}+0.3$	V
T_{oper}	Operating Free Air Temperature Range	-40 to +125	°C
T_{stg}	Storage Temperature Range	-65 to +150	
T_j	Maximum Junction Temperature	150	°C
R_{thja}	Thermal Resistance Junction to Ambient ⁴ SOT23-5 QFN8 SO8 SO14 TSSOP8 TSSOP14	250 50 125 103 120 100	°C/W
ESD	HBM: Human Body Model ⁵	2	kV
	MM: Machine Model ⁶	200	V
	CDM: Charged Device Model	1.5	kV
	Lead Temperature (soldering, 10sec)	260	°C

- 1) All voltage values, except differential voltage are with respect to network ground terminal.
- 2) Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
- 3) The magnitude of input and output voltages must never exceed $V_{CC} + 0.3V$.
- 4) Short-circuits can cause excessive heating and destructive dissipation.
- 5) Human body model, 100pF discharged through a 1.5kΩ resistor into pin of device.
- 6) Machine model ESD, a 200pF cap is charged to the specified voltage, then discharged directly into the IC with no external series resistor (internal resistor < 5Ω), into pin to pin of device.

Table 2: Operating Conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	2.7 to 10	V
V_{icm}	Common Mode Input Voltage Range	$V_{DD} + 1.15$ to $V_{CC} - 1.15$	V
Topper	Operating Free Air Temperature Range	-40 to +125	°C

2 Electrical Characteristics

Table 3: $V_{CC} = +2.5V$, $V_{DD} = -2.5V$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage $T_{min} \leq T_{amb} \leq T_{max}$		1	5 7	mV
DV_{io}	Input Offset Voltage Drift $V_{icm} = 0V$, $V_o = 0V$		5		$\mu V/^\circ C$
I_{io}	Input Offset Current $V_{icm} = 0V$, $V_o = 0V$		10	150	nA
I_{ib}	Input Bias Current $V_{icm} = 0V$, $V_o = 0V$ $T_{min} \leq T_{amb} \leq T_{max}$		200 200	750 1000	nA
V_{icm}	Common Mode Input Voltage Range	-1.35		1.35	V
CMR	Common Mode Rejection Ratio $V_{icm} = \pm 1.35V$	60	85		dB
SVR	Supply Voltage Rejection Ratio $V_{cc} = \pm 2V$ to $\pm 3V$	60	70		dB
A_{vd}	Large Signal Voltage Gain $R_L = 2k\Omega$	70	80		dB
V_{OH}	High Level Output Voltage $R_L = 2k\Omega$	2	2.4		V
V_{OL}	Low Level Output Voltage $R_L = 2k\Omega$		-2.4	-2	V
I_{source}	Output Source Current		1.5		mA
I_{sink}	Output Sink Current		100		mA
I_{cc}	Supply Current - per amplifier Unity gain - No load		2	2.8	mA
GBP	Gain Bandwidth Product $f = 100kHz$ $R_L = 2k\Omega$, $C_L = 100pF$	8.5	12		MHz
SR	Slew Rate $A_V = 1$, $V_{in} = \pm 1V$	2.8	4		$V/\mu s$
$\emptyset m$	Phase Margin at Unit Gain $R_L = 2k\Omega$, $C_L = 100pF$		60		Degrees
Gm	Gain Margin $R_L = 2k\Omega$, $C_L = 100pF$		10		dB
e_n	Equivalent Input Noise Voltage $f = 100kHz$		4		$\frac{nV}{\sqrt{Hz}}$
THD	Total Harmonic Distortion $f = 1KHz$, $A_V = -1$ $R_L = 10k\Omega$		0.003		%

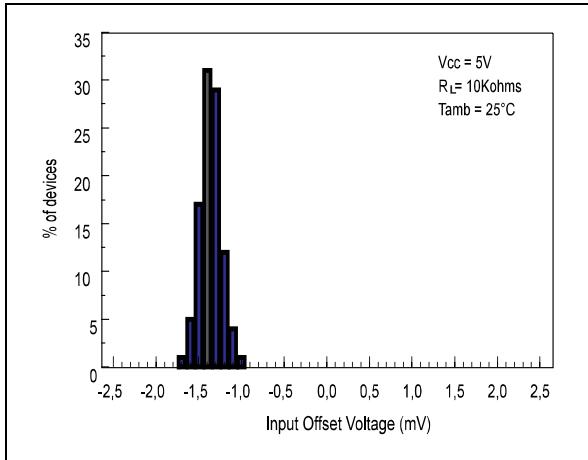
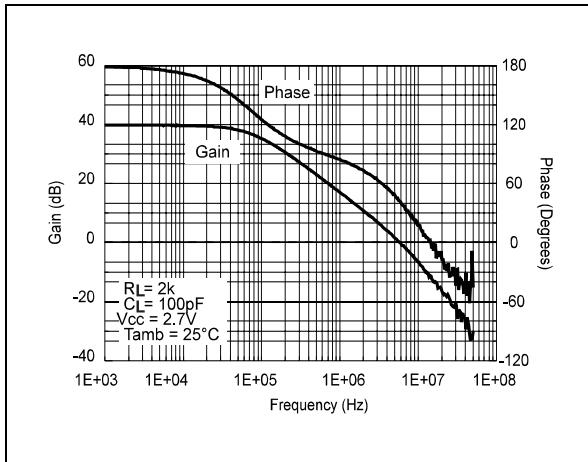
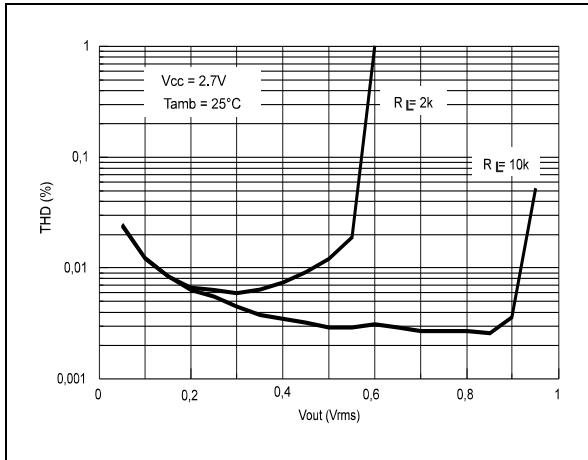
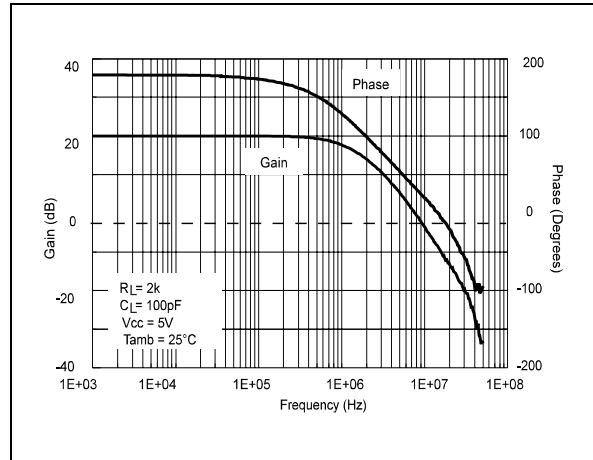
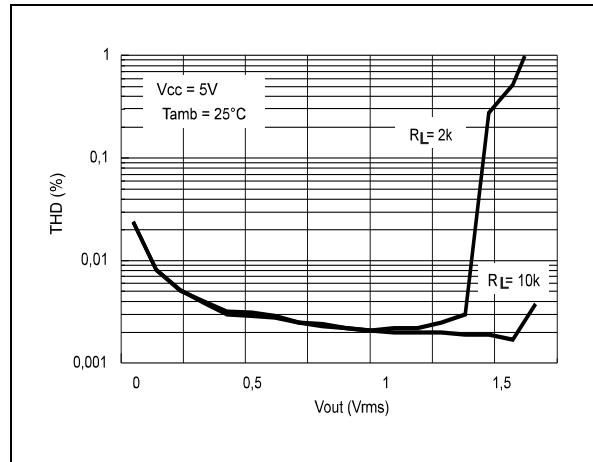
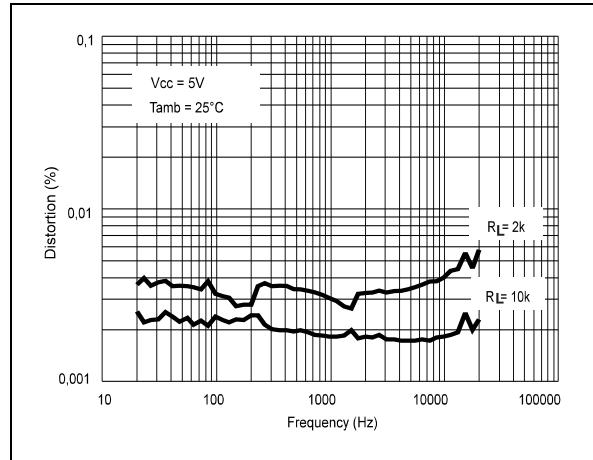
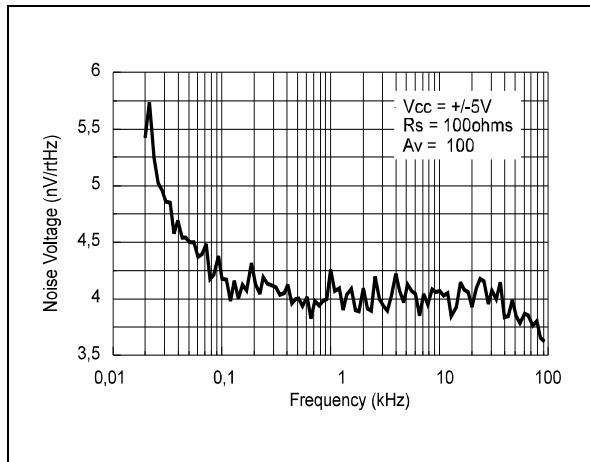
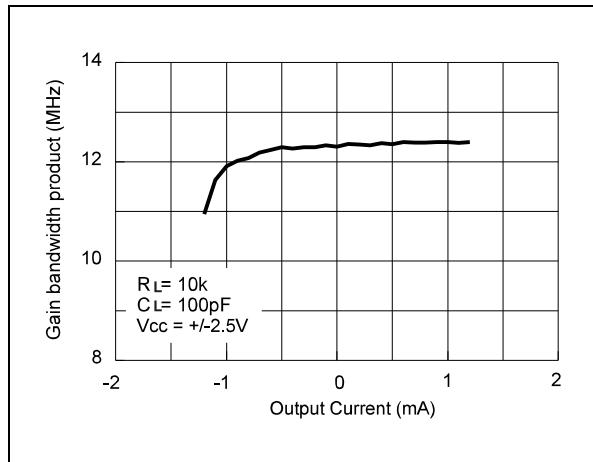
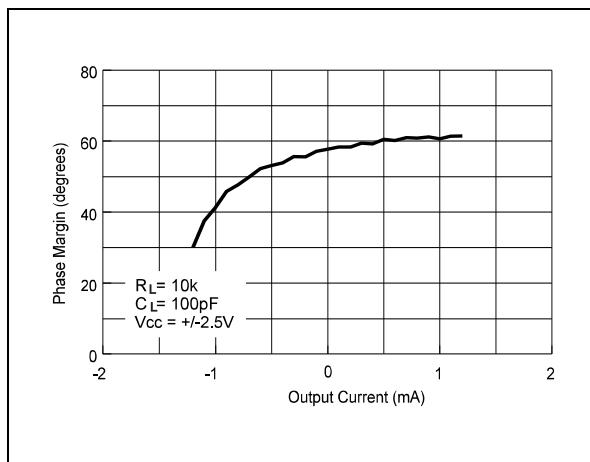
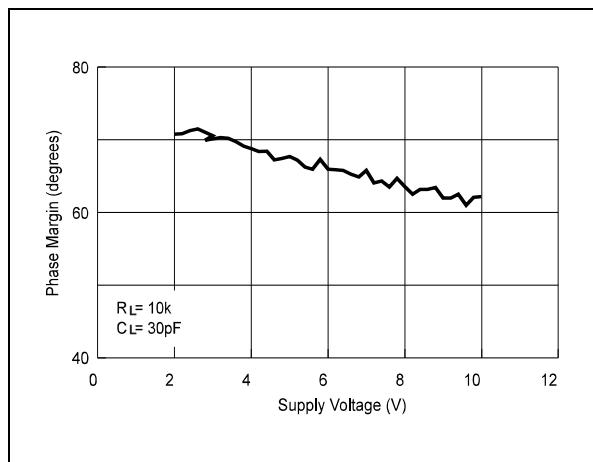
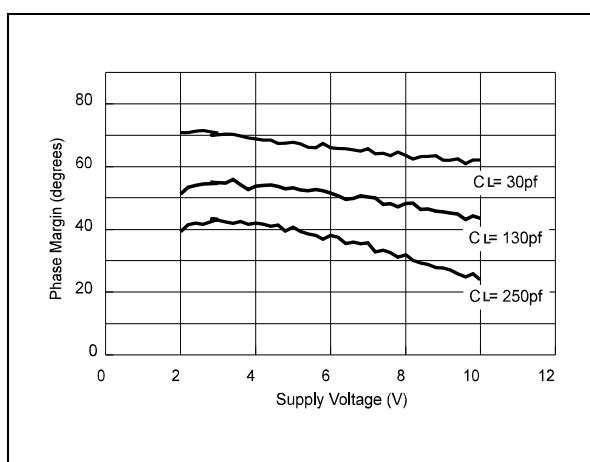
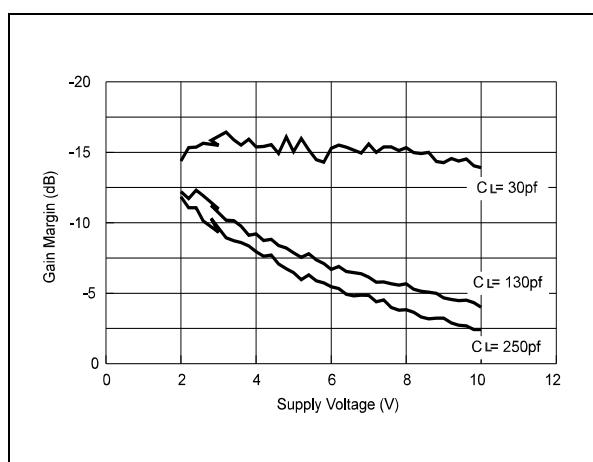
Figure 1: Input offset voltage distribution**Figure 2: Voltage gain & phase vs. frequency****Figure 3: THD vs. Vout****Figure 4: Voltage gain & phase vs. frequency****Figure 5: THD vs. Vout****Figure 6: THD vs. frequency**

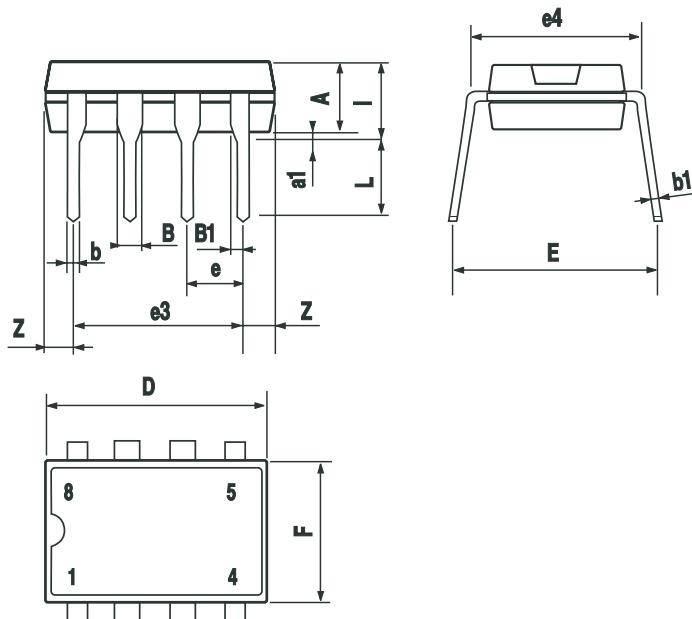
Figure 7: Noise voltage vs. frequency**Figure 10: Gain bandwidth product vs. I_{out}****Figure 8: Phase margin vs. I_{out}****Figure 11: Phase margin vs. V_{cc}****Figure 9: Phase margin vs. V_{cc}****Figure 12: Gain margin vs. V_{cc}**

3 Package Mechanical Data

3.1 DIP8 package

Plastic DIP-8 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A		3.3			0.130	
a1	0.7			0.028		
B	1.39		1.65	0.055		0.065
B1	0.91		1.04	0.036		0.041
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			9.8			0.386
E		8.8			0.346	
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			7.1			0.280
I			4.8			0.189
L		3.3			0.130	
Z	0.44		1.6	0.017		0.063

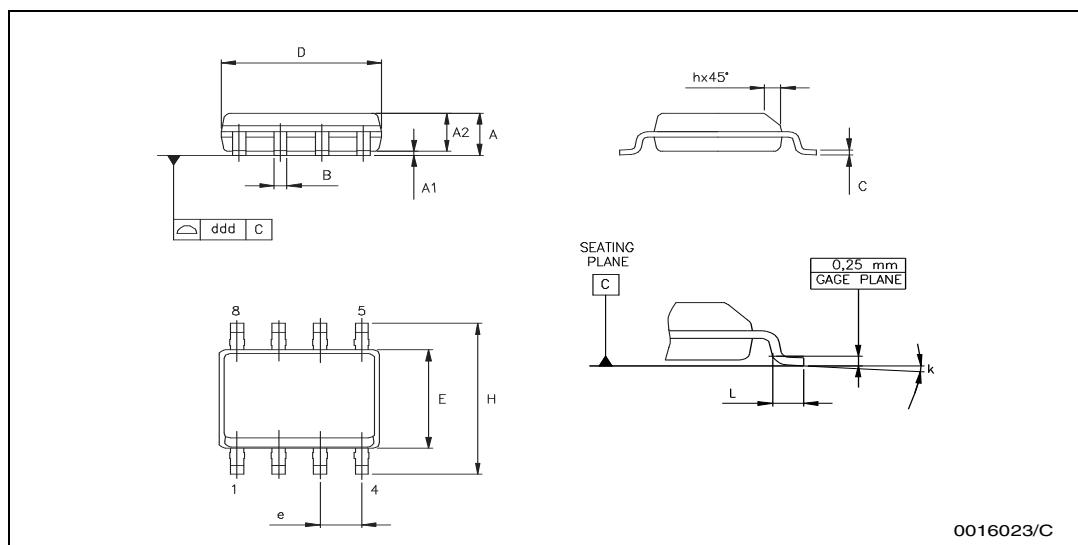


P001F

3.2 SO8 package

SO-8 MECHANICAL DATA

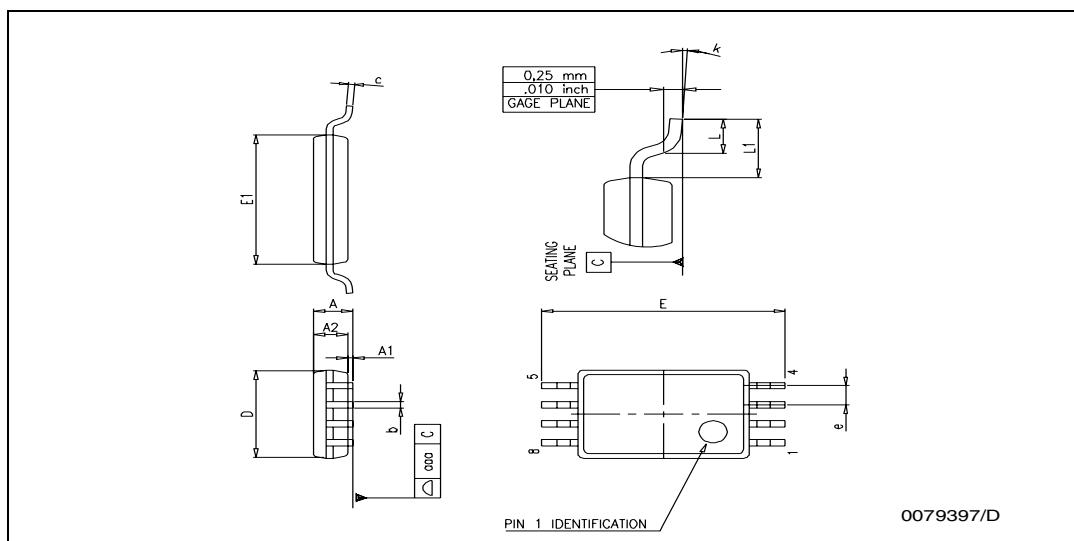
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
e		1.27			0.050	
H	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	8° (max.)					
ddd			0.1			0.04



3.3 TSSOP8 package

TSSOP8 MECHANICAL DATA

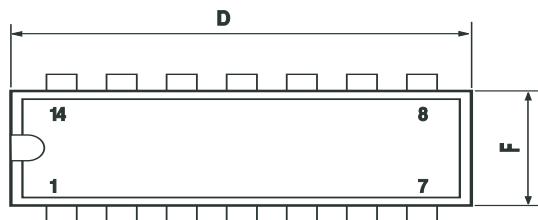
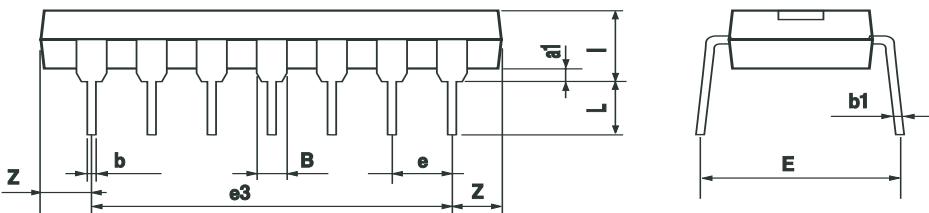
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.0256	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1			0.039	



3.4 DIP14 package

Plastic DIP-14 MECHANICAL DATA

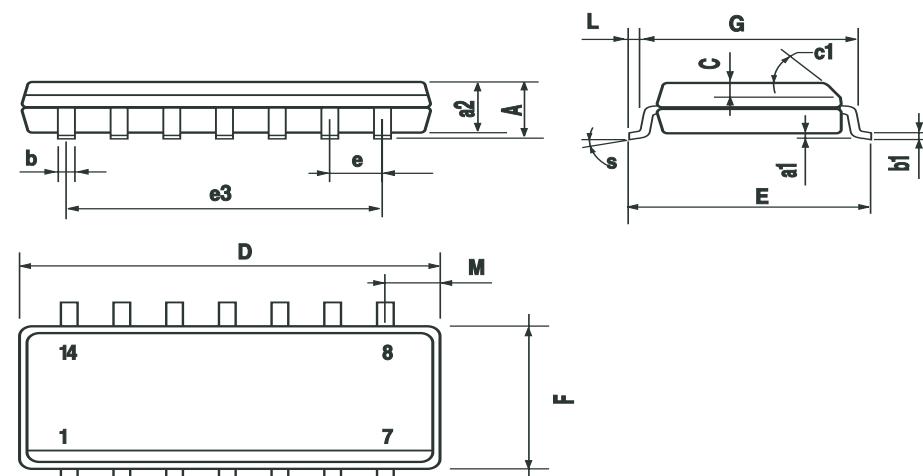
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100



P001A

3.5 SO14 package

SO-14 MECHANICAL DATA						
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1			45° (typ.)			
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S			8° (max.)			

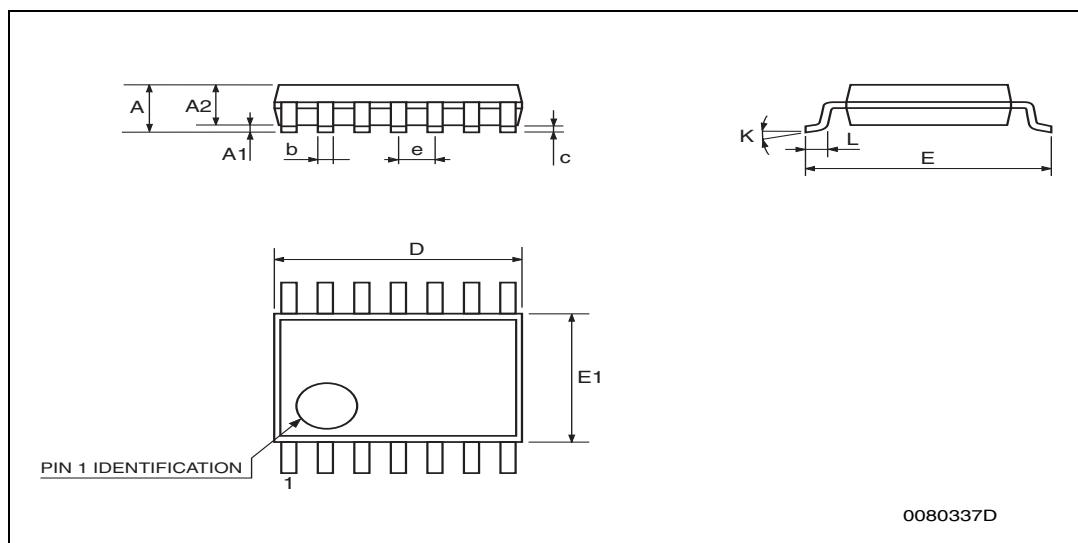


The diagram illustrates the mechanical dimensions of the SO-14 package. It includes three views: a top view showing the footprint with pins numbered 1 through 14; a side view showing the profile with height dimensions A, b, c, d, e, f, g, h, l, m, and s; and a cross-sectional view showing internal features like lead thicknesses a1 and a2, and lead pitch c1. The label 'PO13G' is located at the bottom right of the diagram area.

3.6 TSSOP14 package

TSSOP14 MECHANICAL DATA

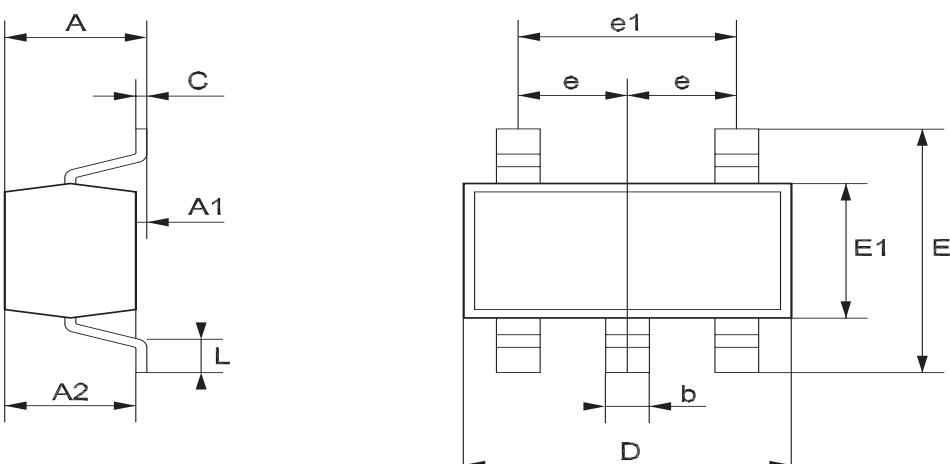
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



3.7 SOT23-5 package

SOT23-5L MECHANICAL DATA

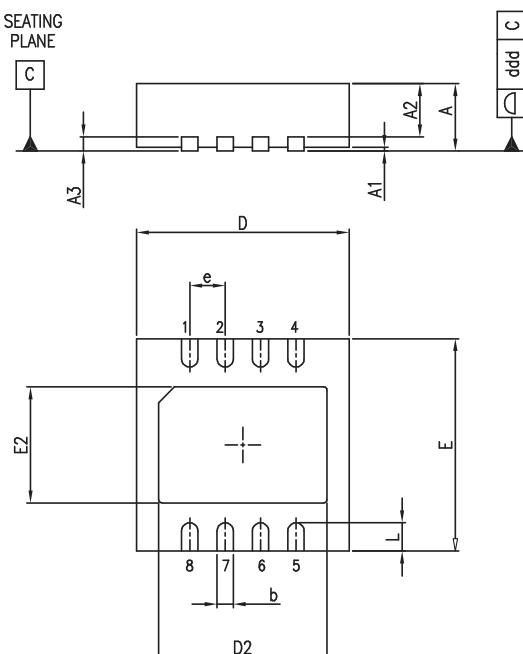
DIM.	mm.			mils		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.0		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
e		0.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6



3.8 DFN8 package

DFN8 (3x3) MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	0.80	0.90	1.00	31.5	35.4	39.4
A1		0.02	0.05		0.8	2.0
A2		0.70			27.6	
A3		0.20			7.9	
b	0.18	0.23	0.30	7.1	9.1	11.8
D	2.875	3.00	3.125		118.1	
D2	2.23	2.38	2.48	87.8	93.7	97.7
E	2.875	3.00	3.125		118.1	
E2	1.49	1.64	1.74	58.7	64.6	68.5
e		0.50			19.7	
L	0.30	0.40	0.50	11.8	15.7	19.7



4 Revision History

Date	Revision	Description of Changes
Nov. 2002	1	First Release
May 2005	3	Modifications on AMR Table 1 on page 3 (explanation of Vid and Vi limits)

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